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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

|                            |   |
|----------------------------|---|
| Product Status             | Discontinued at Digi-Key  |
| Core Processor             | RL78  |
| Core Size                  | 16-Bit  |
| Speed                      | 32MHz   |
| Connectivity               | CSI, I <sup>2</sup> C, LINbus, UART/USART   |
| Peripherals                | DMA, LVD, POR, PWM, WDT   |
| Number of I/O              | 48  |
| Program Memory Size        | 32KB (32K x 8)  |
| Program Memory Type        | FLASH   |
| EEPROM Size                | -   |
| RAM Size                   | 2K x 8  |
| Voltage - Supply (Vcc/Vdd) | 1.6V ~ 5.5V   |
| Data Converters            | A/D 12x8/10b  |
| Oscillator Type            | Internal  |
| Operating Temperature      | -40°C ~ 85°C (TA)   |
| Mounting Type              | Surface Mount   |
| Package / Case             | 64-LQFP   |
| Supplier Device Package    | 64-LFQFP (10x10)  |
| Purchase URL               | <a href="https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f101lcdfb-v0">https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f101lcdfb-v0</a> |

## ○ ROM, RAM capacities

| Flash ROM | Data flash | RAM          | RL78/G13 |          |          |          |          |          |
|-----------|------------|--------------|----------|----------|----------|----------|----------|----------|
|           |            |              | 20 pins  | 24 pins  | 25 pins  | 30 pins  | 32 pins  | 36 pins  |
| 128 KB    | 8 KB       | 12 KB        | –        | –        | –        | R5F100AG | R5F100BG | R5F100CG |
|           | –          |              | –        | –        | –        | R5F101AG | R5F101BG | R5F101CG |
| 96 KB     | 8 KB       | 8 KB         | –        | –        | –        | R5F100AF | R5F100BF | R5F100CF |
|           | –          |              | –        | –        | –        | R5F101AF | R5F101BF | R5F101CF |
| 64 KB     | 4 KB       | 4 KB<br>Note | R5F1006E | R5F1007E | R5F1008E | R5F100AE | R5F100BE | R5F100CE |
|           | –          |              | R5F1016E | R5F1017E | R5F1018E | R5F101AE | R5F101BE | R5F101CE |
| 48 KB     | 4 KB       | 3 KB<br>Note | R5F1006D | R5F1007D | R5F1008D | R5F100AD | R5F100BD | R5F100CD |
|           | –          |              | R5F1016D | R5F1017D | R5F1018D | R5F101AD | R5F101BD | R5F101CD |
| 32 KB     | 4 KB       | 2 KB         | R5F1006C | R5F1007C | R5F1008C | R5F100AC | R5F100BC | R5F100CC |
|           | –          |              | R5F1016C | R5F1017C | R5F1018C | R5F101AC | R5F101BC | R5F101CC |
| 16 KB     | 4 KB       | 2 KB         | R5F1006A | R5F1007A | R5F1008A | R5F100AA | R5F100BA | R5F100CA |
|           | –          |              | R5F1016A | R5F1017A | R5F1018A | R5F101AA | R5F101BA | R5F101CA |

| Flash ROM | Data flash | RAM           | RL78/G13 |          |          |          |          |          |          |          |
|-----------|------------|---------------|----------|----------|----------|----------|----------|----------|----------|----------|
|           |            |               | 40 pins  | 44 pins  | 48 pins  | 52 pins  | 64 pins  | 80 pins  | 100 pins | 128 pins |
| 512 KB    | 8 KB       | 32 KB<br>Note | –        | R5F100FL | R5F100GL | R5F100JL | R5F100LL | R5F100ML | R5F100PL | R5F100SL |
|           | –          |               | –        | R5F101FL | R5F101GL | R5F101JL | R5F101LL | R5F101ML | R5F101PL | R5F101SL |
| 384 KB    | 8 KB       | 24 KB         | –        | R5F100FK | R5F100GK | R5F100JK | R5F100LK | R5F100MK | R5F100PK | R5F100SK |
|           | –          |               | –        | R5F101FK | R5F101GK | R5F101JK | R5F101LK | R5F101MK | R5F101PK | R5F101SK |
| 256 KB    | 8 KB       | 20 KB<br>Note | –        | R5F100FJ | R5F100GJ | R5F100JJ | R5F100LJ | R5F100MJ | R5F100PJ | R5F100SJ |
|           | –          |               | –        | R5F101FJ | R5F101GJ | R5F101JJ | R5F101LJ | R5F101MJ | R5F101PJ | R5F101SJ |
| 192 KB    | 8 KB       | 16 KB         | R5F100EH | R5F100FH | R5F100GH | R5F100JH | R5F100LH | R5F100MH | R5F100PH | R5F100SH |
|           | –          |               | R5F101EH | R5F101FH | R5F101GH | R5F101JH | R5F101LH | R5F101MH | R5F101PH | R5F101SH |
| 128 KB    | 8 KB       | 12 KB         | R5F100EG | R5F100FG | R5F100GG | R5F100JG | R5F100LG | R5F100MG | R5F100PG | –        |
|           | –          |               | R5F101EG | R5F101FG | R5F101GG | R5F101JG | R5F101LG | R5F101MG | R5F101PG | –        |
| 96 KB     | 8 KB       | 8 KB          | R5F100EF | R5F100FF | R5F100GF | R5F100JF | R5F100LF | R5F100MF | R5F100PF | –        |
|           | –          |               | R5F101EF | R5F101FF | R5F101GF | R5F101JF | R5F101LF | R5F101MF | R5F101PF | –        |
| 64 KB     | 4 KB       | 4 KB<br>Note  | R5F100EE | R5F100FE | R5F100GE | R5F100JE | R5F100LE | –        | –        | –        |
|           | –          |               | R5F101EE | R5F101FE | R5F101GE | R5F101JE | R5F101LE | –        | –        | –        |
| 48 KB     | 4 KB       | 3 KB<br>Note  | R5F100ED | R5F100FD | R5F100GD | R5F100JD | R5F100LD | –        | –        | –        |
|           | –          |               | R5F101ED | R5F101FD | R5F101GD | R5F101JD | R5F101LD | –        | –        | –        |
| 32 KB     | 4 KB       | 2 KB          | R5F100EC | R5F100FC | R5F100GC | R5F100JC | R5F100LC | –        | –        | –        |
|           | –          |               | R5F101EC | R5F101FC | R5F101GC | R5F101JC | R5F101LC | –        | –        | –        |
| 16 KB     | 4 KB       | 2 KB          | R5F100EA | R5F100FA | R5F100GA | –        | –        | –        | –        | –        |
|           | –          |               | R5F101EA | R5F101FA | R5F101GA | –        | –        | –        | –        | –        |

**Note** The flash library uses RAM in self-programming and rewriting of the data flash memory.

The target products and start address of the RAM areas used by the flash library are shown below.

R5F100xD, R5F101xD (x = 6 to 8, A to C, E to G, J, L): Start address FF300H

R5F100xE, R5F101xE (x = 6 to 8, A to C, E to G, J, L): Start address FEF00H

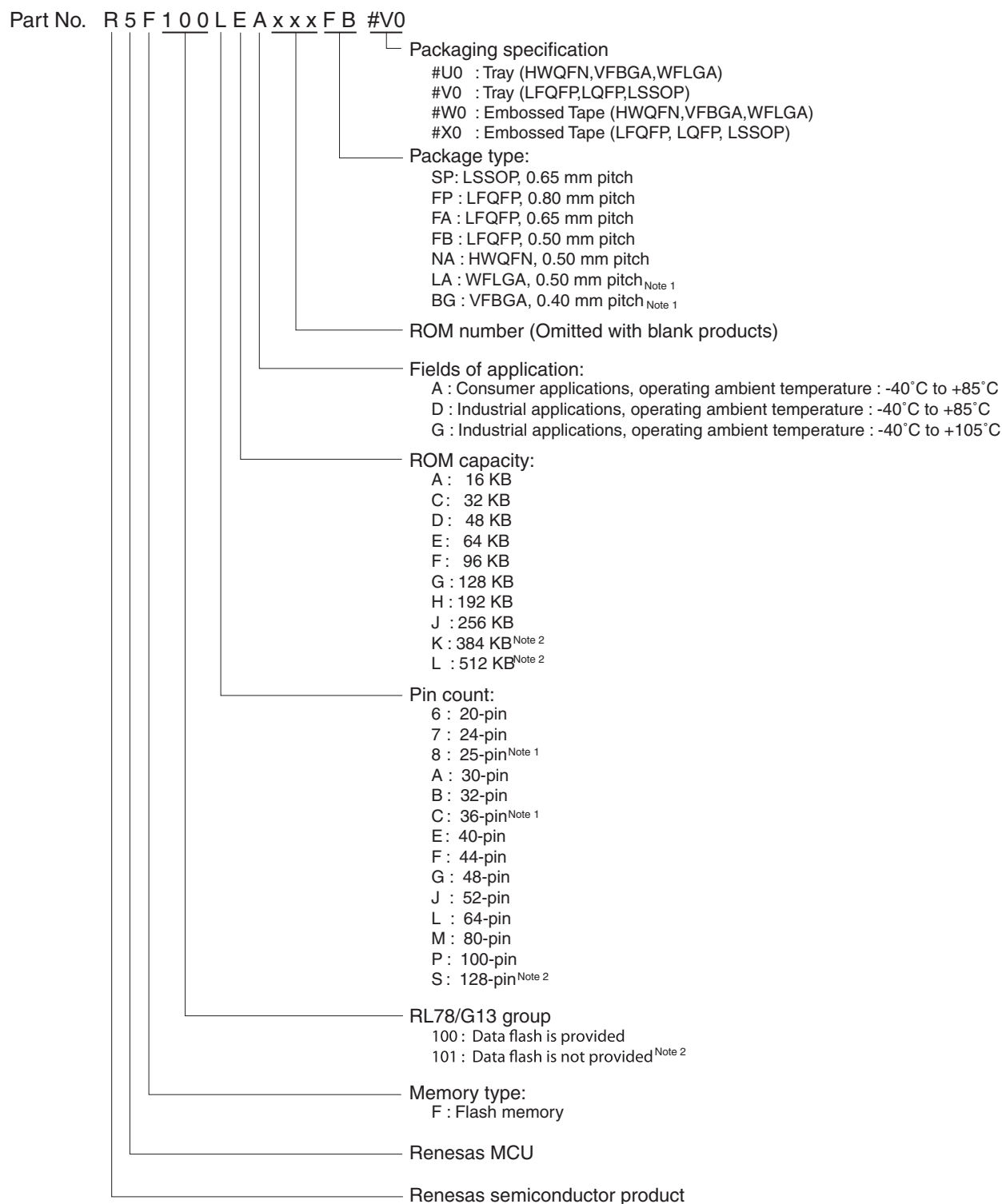
R5F100xJ, R5F101xJ (x = F, G, J, L, M, P): Start address FAF00H

R5F100xL, R5F101xL (x = F, G, J, L, M, P, S): Start address F7F00H

For the RAM areas used by the flash library, see **Self RAM list of Flash Self-Programming Library for RL78 Family (R20UT2944)**.

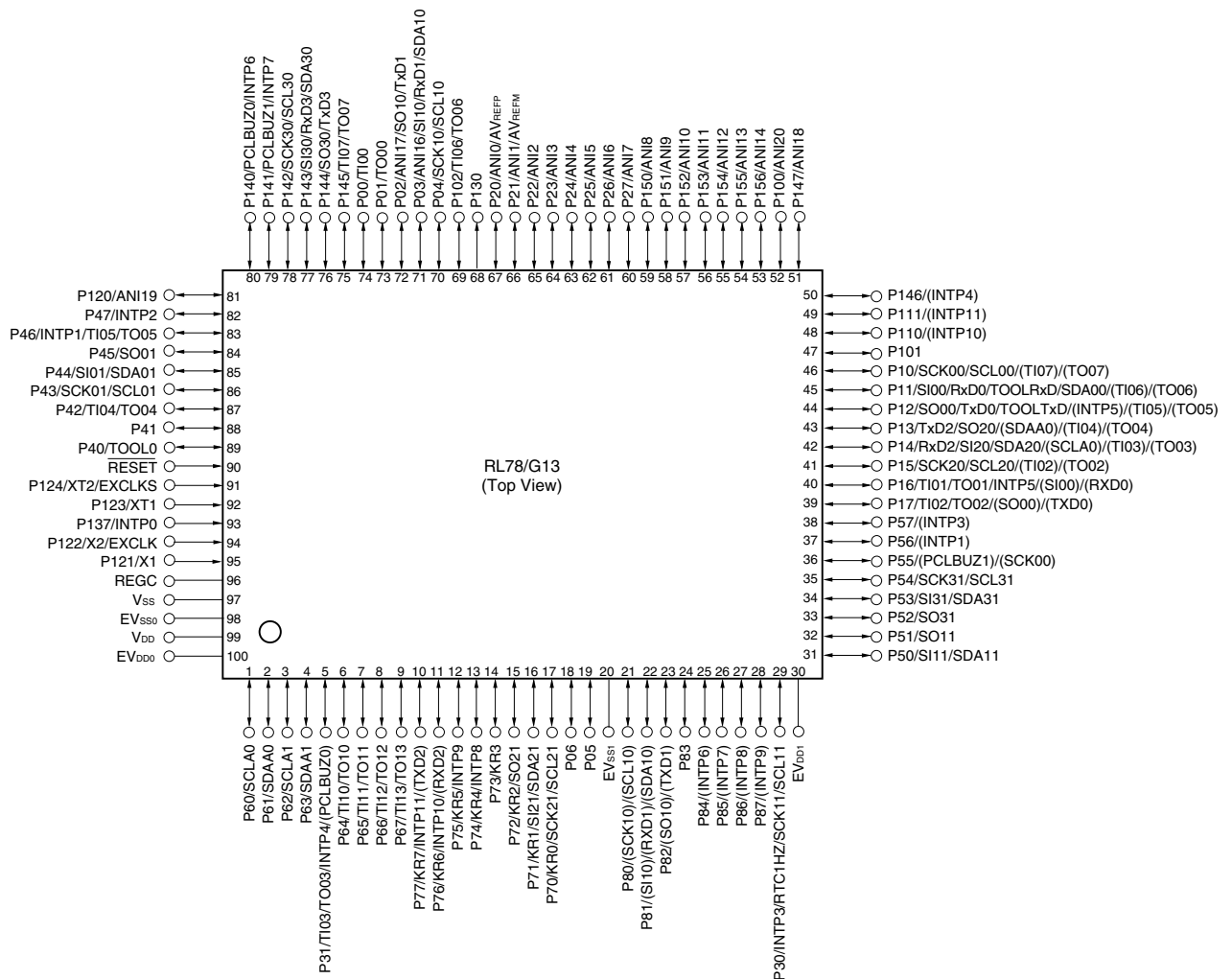
## 1.2 List of Part Numbers

Figure 1-1. Part Number, Memory Size, and Package of RL78/G13



- Notes**
1. Products only for "A: Consumer applications ( $T_A = -40$  to  $+85^\circ\text{C}$ )", and "G: Industrial applications ( $T_A = -40$  to  $+105^\circ\text{C}$ )"
  2. Products only for "A: Consumer applications ( $T_A = -40$  to  $+85^\circ\text{C}$ )", and "D: Industrial applications ( $T_A = -40$  to  $+85^\circ\text{C}$ )"

- 100-pin plastic LQFP (14 × 20 mm, 0.65 mm pitch)



- Cautions**
1. Make EV<sub>SS0</sub>, EV<sub>SS1</sub> pins the same potential as V<sub>SS</sub> pin.
  2. Make V<sub>DD</sub> pin the potential that is higher than EV<sub>DD0</sub>, EV<sub>DD1</sub> pins (EV<sub>DD0</sub> = EV<sub>DD1</sub>).
  3. Connect the REGC pin to V<sub>SS</sub> via a capacitor (0.47 to 1  $\mu$ F).

- Remarks**
1. For pin identification, see 1.4 Pin Identification.
  2. When using the microcontroller for an application where the noise generated inside the microcontroller must be reduced, it is recommended to supply separate powers to the V<sub>DD</sub>, EV<sub>DD0</sub> and EV<sub>DD1</sub> pins and connect the V<sub>SS</sub>, EV<sub>SS0</sub> and EV<sub>SS1</sub> pins to separate ground lines.
  3. Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.

## 1.4 Pin Identification

|                   |  |  |  |
|-------------------|--|--|--|
| ANI0 to ANI14,    |  | REGC:  | Regulator capacitance                          |
| ANI16 to ANI26:   | Analog input                                     | RESET:   | Reset  |
| AVREFM:           | A/D converter reference potential (– side) input | RTC1HZ:  | Real-time clock correction clock (1 Hz) output |
| AVREFP:           | A/D converter reference potential (+ side) input | RxD0 to RxD3:  | Receive data                                   |
| EVDD0, EVDD1:     | Power supply for port                            | SCK00, SCK01, SCK10, SCK11, SCK20, SCK21,                      |  |
| EVSS0, EVSS1:     | Ground for port                                  | SCLA0, SCLA1:  | Serial clock input/output                      |
| EXCLK:            | External clock input (Main system clock)         | SCLA0, SCLA1, SCL00, SCL01, SCL10, SCL11,                      |  |
| EXCLKS:           | External clock input (Subsystem clock)           | SCL20, SCL21, SCL30, SCL31:                                    | Serial clock output                            |
| INTP0 to INTP11:  | Interrupt request from peripheral                | SDAA0, SDAA1, SDA00, SDA01, SDA10, SDA11, SDA20, SDA21, SDA30, |  |
| KR0 to KR7:       | Key return                                       | SDA31:   | Serial data input/output                       |
| P00 to P07:       | Port 0   | SI00, SI01, SI10, SI11,  |  |
| P10 to P17:       | Port 1   | SI20, SI21, SI30, SI31:  | Serial data input                              |
| P20 to P27:       | Port 2   | SO00, SO01, SO10,  |  |
| P30 to P37:       | Port 3   | SO11, SO20, SO21,  |  |
| P40 to P47:       | Port 4   | SO30, SO31:  | Serial data output                             |
| P50 to P57:       | Port 5   | TI00 to TI07,  |  |
| P60 to P67:       | Port 6   | TI10 to TI17:  | Timer input                                    |
| P70 to P77:       | Port 7   | TO00 to TO07,  |  |
| P80 to P87:       | Port 8   | TO10 to TO17:  | Timer output                                   |
| P90 to P97:       | Port 9   | TOOL0:   | Data input/output for tool                     |
| P100 to P106:     | Port 10  | TOOLRxD, TOOLTxD:  | Data input/output for external device          |
| P110 to P117:     | Port 11  | TxD0 to TxD3:  | Transmit data                                  |
| P120 to P127:     | Port 12  | V <sub>DD</sub> :  | Power supply                                   |
| P130, P137:       | Port 13  | V <sub>SS</sub> :  | Ground   |
| P140 to P147:     | Port 14  | X1, X2:  | Crystal oscillator (main system clock)         |
| P150 to P156:     | Port 15  | XT1, XT2:  | Crystal oscillator (subsystem clock)           |
| PCLBUZ0, PCLBUZ1: | Programmable clock output/buzzer output          |  |  |

3. The number of PWM outputs varies depending on the setting of channels in use (the number of masters and slaves) (see **6.9.3 Operation as multiple PWM output function** in the RL78/G13 User's Manual).
4. When setting to PIOR = 1

(2/2)

| Item  | 20-pin  |          | 24-pin     |          | 25-pin     |          | 30-pin     |          | 32-pin     |          | 36-pin     |          |
|---|---|----------|------------|----------|------------|----------|------------|----------|------------|----------|------------|----------|
|   | R5F1006x  | R5F1016x | R5F1007x   | R5F1017x | R5F1008x   | R5F1018x | R5F100Ax   | R5F101Ax | R5F100Bx   | R5F101Bx | R5F100Cx   | R5F101Cx |
| Clock output/buzzer output                  | —   |          | 1          |          | 1          |          | 2          |          | 2          |          | 2          |          |
|   | • 2.44 kHz, 4.88 kHz, 9.76 kHz, 1.25 MHz, 2.5 MHz, 5 MHz, 10 MHz<br>(Main system clock: f <sub>MAIN</sub> = 20 MHz operation)   |          |            |          |            |          |            |          |            |          |            |          |
| 8/10-bit resolution A/D converter           | 6 channels  |          | 6 channels |          | 6 channels |          | 8 channels |          | 8 channels |          | 8 channels |          |
| Serial interface                            | [20-pin, 24-pin, 25-pin products]<br>• CSI: 1 channel/simplified I <sup>2</sup> C: 1 channel/UART: 1 channel<br>• CSI: 1 channel/simplified I <sup>2</sup> C: 1 channel/UART: 1 channel<br>[30-pin, 32-pin products]<br>• CSI: 1 channel/simplified I <sup>2</sup> C: 1 channel/UART: 1 channel<br>• CSI: 1 channel/simplified I <sup>2</sup> C: 1 channel/UART: 1 channel<br>• CSI: 1 channel/simplified I <sup>2</sup> C: 1 channel/UART (UART supporting LIN-bus): 1 channel<br>[36-pin products]<br>• CSI: 1 channel/simplified I <sup>2</sup> C: 1 channel/UART: 1 channel<br>• CSI: 1 channel/simplified I <sup>2</sup> C: 1 channel/UART: 1 channel<br>• CSI: 2 channels/simplified I <sup>2</sup> C: 2 channels/UART (UART supporting LIN-bus): 1 channel |          |            |          |            |          |            |          |            |          |            |          |
|   | I <sup>2</sup> C bus  | —        | 1 channel  |          | 1 channel  |          | 1 channel  |          | 1 channel  |          | 1 channel  |          |
| Multiplier and divider/multiply-accumulator | • 16 bits × 16 bits = 32 bits (Unsigned or signed)<br>• 32 bits ÷ 32 bits = 32 bits (Unsigned)<br>• 16 bits × 16 bits + 32 bits = 32 bits (Unsigned or signed)  |          |            |          |            |          |            |          |            |          |            |          |
| DMA controller                              | 2 channels  |          |            |          |            |          |            |          |            |          |            |          |
| Vectored interrupt sources                  | Internal  | 23       | 24         |          | 24         |          | 27         |          | 27         |          | 27         |          |
|   | External  | 3        | 5          |          | 5          |          | 6          |          | 6          |          | 6          |          |
| Key interrupt                               | —   |          |            |          |            |          |            |          |            |          |            |          |
| Reset                                       | • Reset by $\overline{\text{RESET}}$ pin<br>• Internal reset by watchdog timer<br>• Internal reset by power-on-reset<br>• Internal reset by voltage detector<br>• Internal reset by illegal instruction execution <sup>Note</sup><br>• Internal reset by RAM parity error<br>• Internal reset by illegal-memory access  |          |            |          |            |          |            |          |            |          |            |          |
| Power-on-reset circuit                      | • Power-on-reset: 1.51 V (TYP.)<br>• Power-down-reset: 1.50 V (TYP.)  |          |            |          |            |          |            |          |            |          |            |          |
| Voltage detector                            | • Rising edge : 1.67 V to 4.06 V (14 stages)<br>• Falling edge : 1.63 V to 3.98 V (14 stages)   |          |            |          |            |          |            |          |            |          |            |          |
| On-chip debug function                      | Provided  |          |            |          |            |          |            |          |            |          |            |          |
| Power supply voltage                        | V <sub>DD</sub> = 1.6 to 5.5 V (T <sub>A</sub> = -40 to +85°C)<br>V <sub>DD</sub> = 2.4 to 5.5 V (T <sub>A</sub> = -40 to +105°C)   |          |            |          |            |          |            |          |            |          |            |          |
| Operating ambient temperature               | T <sub>A</sub> = 40 to +85°C (A: Consumer applications, D: Industrial applications )<br>T <sub>A</sub> = 40 to +105°C (G: Industrial applications)  |          |            |          |            |          |            |          |            |          |            |          |

**Note** The illegal instruction is generated when instruction code FFH is executed.

Reset by the illegal instruction execution not issued by emulation with the in-circuit emulator or on-chip debug emulator.

**Absolute Maximum Ratings (T<sub>A</sub> = 25°C) (2/2)**

| Parameter                     | Symbols                          | Conditions                   |  | Ratings  | Unit       |
|-------------------------------|----------------------------------|------------------------------|--|--|------------|
| Output current, high          | I <sub>OH1</sub>                 | Per pin                      | P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P130, P140 to P147 | −40  | mA         |
|                               |                                  | Total of all pins<br>−170 mA | P00 to P04, P07, P32 to P37, P40 to P47, P102 to P106, P120, P125 to P127, P130, P140 to P145  | −70  | mA         |
|                               |                                  |                              | P05, P06, P10 to P17, P30, P31, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100, P101, P110 to P117, P146, P147   | −100   | mA         |
|                               | I <sub>OH2</sub>                 | Per pin                      | P20 to P27, P150 to P156   | −0.5   | mA         |
|                               |                                  | Total of all pins            |  | −2   | mA         |
|                               | Output current, low              | I <sub>OL1</sub>             | Per pin  | P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P130, P140 to P147 | 40         |
| Total of all pins<br>170 mA   |                                  |                              | P00 to P04, P07, P32 to P37, P40 to P47, P102 to P106, P120, P125 to P127, P130, P140 to P145  | 70   | mA         |
|                               |                                  |                              | P05, P06, P10 to P17, P30, P31, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, P100, P101, P110 to P117, P146, P147   | 100  | mA         |
| I <sub>OL2</sub>              |                                  | Per pin                      | P20 to P27, P150 to P156   | 1  | mA         |
|                               |                                  | Total of all pins            |  | 5  | mA         |
| Operating ambient temperature |                                  | T <sub>A</sub>               | In normal operation mode   |  | −40 to +85 |
|                               | In flash memory programming mode |                              |  |  |            |
| Storage temperature           | T <sub>stg</sub>                 |                              |  | −65 to +150  | °C         |

**Caution** Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

**Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

- Notes**
1. Total current flowing into V<sub>DD</sub> and EV<sub>DD0</sub>, including the input leakage current flowing when the level of the input pin is fixed to V<sub>DD</sub>, EV<sub>DD0</sub> or V<sub>SS</sub>, EV<sub>SS0</sub>. The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.
  2. When high-speed on-chip oscillator and subsystem clock are stopped.
  3. When high-speed system clock and subsystem clock are stopped.
  4. When high-speed on-chip oscillator and high-speed system clock are stopped. When AMPHS1 = 1 (Ultra-low power consumption oscillation). However, not including the current flowing into the RTC, 12-bit interval timer, and watchdog timer.
  5. Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.
    - HS (high-speed main) mode:  $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$  @ 1 MHz to 32 MHz
    - $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$  @ 1 MHz to 16 MHz
    - LS (low-speed main) mode:  $1.8\text{ V} \leq V_{DD} \leq 5.5\text{ V}$  @ 1 MHz to 8 MHz
    - LV (low-voltage main) mode:  $1.6\text{ V} \leq V_{DD} \leq 5.5\text{ V}$  @ 1 MHz to 4 MHz

- Remarks**
1. f<sub>MX</sub>: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
  2. f<sub>IH</sub>: High-speed on-chip oscillator clock frequency
  3. f<sub>SUB</sub>: Subsystem clock frequency (XT1 clock oscillation frequency)
  4. Except subsystem clock operation, temperature condition of the TYP. value is T<sub>A</sub> = 25°C



- Notes**
1. Total current flowing into V<sub>DD</sub>, EV<sub>DD0</sub>, and EV<sub>DD1</sub>, including the input leakage current flowing when the level of the input pin is fixed to V<sub>DD</sub>, EV<sub>DD0</sub>, and EV<sub>DD1</sub>, or V<sub>SS</sub>, EV<sub>SS0</sub>, and EV<sub>SS1</sub>. The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.
  2. When high-speed on-chip oscillator and subsystem clock are stopped.
  3. When high-speed system clock and subsystem clock are stopped.
  4. When high-speed on-chip oscillator and high-speed system clock are stopped. When AMPHS1 = 1 (Ultra-low power consumption oscillation). However, not including the current flowing into the RTC, 12-bit interval timer, and watchdog timer.
  5. Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.
    - HS (high-speed main) mode:  $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V} @ 1\text{ MHz to }32\text{ MHz}$   
 $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V} @ 1\text{ MHz to }16\text{ MHz}$
    - LS (low-speed main) mode:  $1.8\text{ V} \leq V_{DD} \leq 5.5\text{ V} @ 1\text{ MHz to }8\text{ MHz}$
    - LV (low-voltage main) mode:  $1.6\text{ V} \leq V_{DD} \leq 5.5\text{ V} @ 1\text{ MHz to }4\text{ MHz}$

- Remarks**
1. f<sub>MX</sub>: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
  2. f<sub>IH</sub>: High-speed on-chip oscillator clock frequency
  3. f<sub>SUB</sub>: Subsystem clock frequency (XT1 clock oscillation frequency)
  4. Except subsystem clock operation, temperature condition of the TYP. value is T<sub>A</sub> = 25°C

**(4) Peripheral Functions (Common to all products)****(T<sub>A</sub> = -40 to +85°C, 1.6 V ≤ EV<sub>DD0</sub> = EV<sub>DD1</sub> ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS0</sub> = EV<sub>SS1</sub> = 0 V)**

| Parameter                                      | Symbol                                    | Conditions                       |   | MIN. | TYP. | MAX.  | Unit |
|--|---|----------------------------------|---|------|------|-------|------|
| Low-speed on-chip oscillator operating current | I <sub>FIL</sub> <sup>Note 1</sup>        |                                  |   |      | 0.20 |       | μA   |
| RTC operating current                          | I <sub>RTC</sub> <sup>Notes 1, 2, 3</sup> |                                  |   |      | 0.02 |       | μA   |
| 12-bit interval timer operating current        | I <sub>IT</sub> <sup>Notes 1, 2, 4</sup>  |                                  |   |      | 0.02 |       | μA   |
| Watchdog timer operating current               | I <sub>WDT</sub> <sup>Notes 1, 2, 5</sup> | f <sub>IL</sub> = 15 kHz         |   |      | 0.22 |       | μA   |
| A/D converter operating current                | I <sub>ADC</sub> <sup>Notes 1, 6</sup>    | When conversion at maximum speed | Normal mode, AV <sub>REFP</sub> = V <sub>DD</sub> = 5.0 V   |      | 1.3  | 1.7   | mA   |
|  |   |                                  | Low voltage mode, AV <sub>REFP</sub> = V <sub>DD</sub> = 3.0 V  |      | 0.5  | 0.7   | mA   |
| A/D converter reference voltage current        | I <sub>ADREF</sub> <sup>Note 1</sup>      |                                  |   |      | 75.0 |       | μA   |
| Temperature sensor operating current           | I <sub>TMPS</sub> <sup>Note 1</sup>       |                                  |   |      | 75.0 |       | μA   |
| LVD operating current                          | I <sub>LVI</sub> <sup>Notes 1, 7</sup>    |                                  |   |      | 0.08 |       | μA   |
| Self-programming operating current             | I <sub>FSP</sub> <sup>Notes 1, 9</sup>    |                                  |   |      | 2.50 | 12.20 | mA   |
| BGO operating current                          | I <sub>BGO</sub> <sup>Notes 1, 8</sup>    |                                  |   |      | 2.50 | 12.20 | mA   |
| SNOOZE operating current                       | I <sub>SNOZ</sub> <sup>Note 1</sup>       | ADC operation                    | The mode is performed <sup>Note 10</sup>  |      | 0.50 | 0.60  | mA   |
|  |   |                                  | The A/D conversion operations are performed, Low voltage mode, AV <sub>REFP</sub> = V <sub>DD</sub> = 3.0 V |      | 1.20 | 1.44  | mA   |
|  |   | CSI/UART operation               |   |      | 0.70 | 0.84  | mA   |

**Notes** 1. Current flowing to V<sub>DD</sub>.

2. When high speed on-chip oscillator and high-speed system clock are stopped.
3. Current flowing only to the real-time clock (RTC) (excluding the operating current of the low-speed on-chip oscillator and the XT1 oscillator). The supply current of the RL78 microcontrollers is the sum of the values of either I<sub>DD1</sub> or I<sub>DD2</sub>, and I<sub>RTC</sub>, when the real-time clock operates in operation mode or HALT mode. When the low-speed on-chip oscillator is selected, I<sub>FIL</sub> should be added. I<sub>DD2</sub> subsystem clock operation includes the operational current of the real-time clock.
4. Current flowing only to the 12-bit interval timer (excluding the operating current of the low-speed on-chip oscillator and the XT1 oscillator). The supply current of the RL78 microcontrollers is the sum of the values of either I<sub>DD1</sub> or I<sub>DD2</sub>, and I<sub>IT</sub>, when the 12-bit interval timer operates in operation mode or HALT mode. When the low-speed on-chip oscillator is selected, I<sub>FIL</sub> should be added.
5. Current flowing only to the watchdog timer (including the operating current of the low-speed on-chip oscillator). The supply current of the RL78 microcontrollers is the sum of I<sub>DD1</sub>, I<sub>DD2</sub> or I<sub>DD3</sub> and I<sub>WDT</sub> when the watchdog timer is in operation.

**Note** The following conditions are required for low voltage interface when  $E_{VDD0} < V_{DD}$

$1.8\text{ V} \leq E_{VDD0} < 2.7\text{ V}$  : MIN. 125 ns

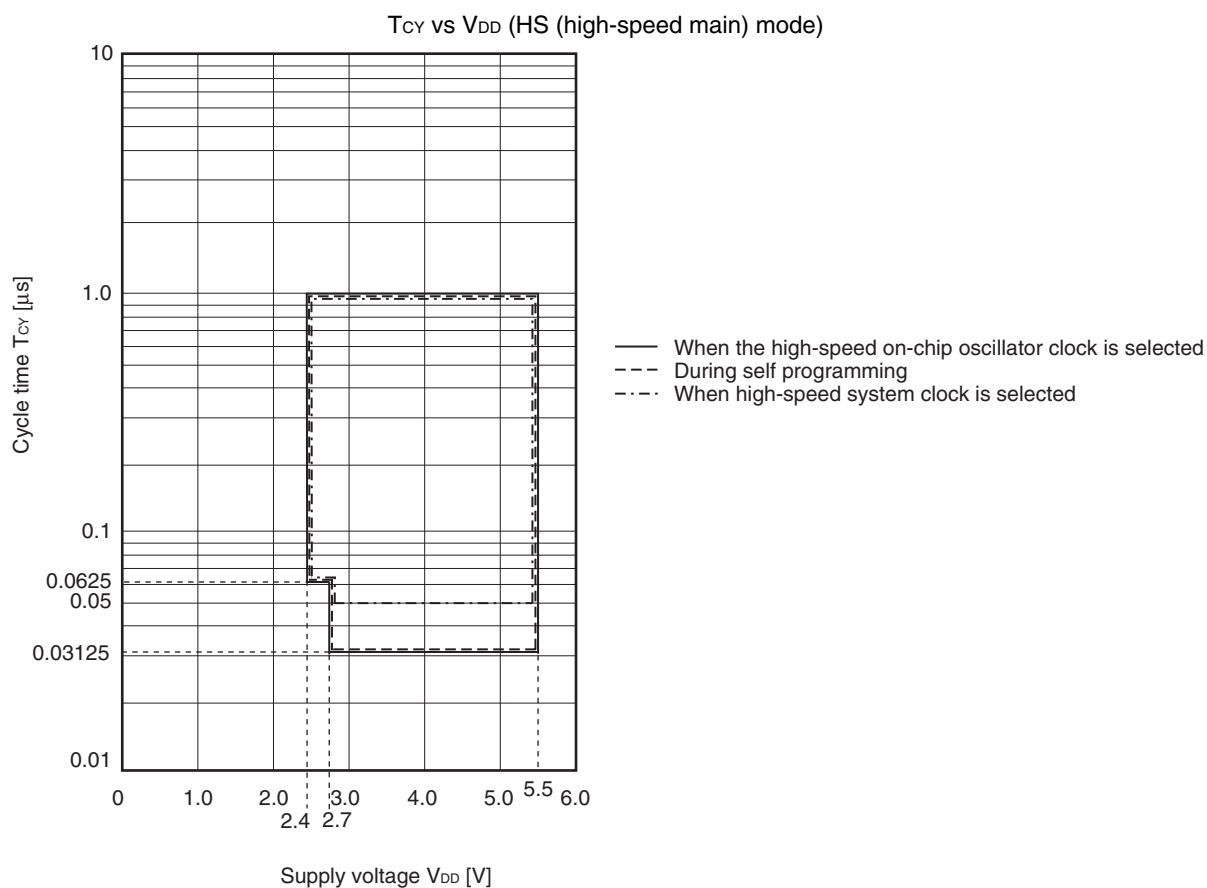
$1.6\text{ V} \leq E_{VDD0} < 1.8\text{ V}$  : MIN. 250 ns

**Remark**  $f_{MCK}$ : Timer array unit operation clock frequency

(Operation clock to be set by the CKSmn0, CKSmn1 bits of timer mode register mn (TMRmn).

m: Unit number ( $m = 0, 1$ ), n: Channel number ( $n = 0$  to  $7$ ))

### Minimum Instruction Execution Time during Main System Clock Operation



**(5) During communication at same potential (simplified I<sup>2</sup>C mode) (2/2)****(T<sub>A</sub> = -40 to +85°C, 1.6 V ≤ EV<sub>DD0</sub> = EV<sub>DD1</sub> ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS0</sub> = EV<sub>SS1</sub> = 0 V)**

| Parameter                     | Symbol              | Conditions  | HS (high-speed main) Mode            |      | LS (low-speed main) Mode             |      | LV (low-voltage main) Mode           |      | Unit |
|-------------------------------|---------------------|---|--------------------------------------|------|--------------------------------------|------|--------------------------------------|------|------|
|                               |                     |   | MIN.                                 | MAX. | MIN.                                 | MAX. | MIN.                                 | MAX. |      |
| Data setup time (reception)   | t <sub>SU:DAT</sub> | 2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V,<br>C <sub>b</sub> = 50 pF, R <sub>b</sub> = 2.7 kΩ | 1/f <sub>MCK</sub><br>+ 85<br>Note2  |      | 1/f <sub>MCK</sub><br>+ 145<br>Note2 |      | 1/f <sub>MCK</sub><br>+ 145<br>Note2 |      | ns   |
|                               |                     | 1.8 V ≤ EV <sub>DD0</sub> ≤ 5.5 V,<br>C <sub>b</sub> = 100 pF, R <sub>b</sub> = 3 kΩ  | 1/f <sub>MCK</sub><br>+ 145<br>Note2 |      | 1/f <sub>MCK</sub><br>+ 145<br>Note2 |      | 1/f <sub>MCK</sub><br>+ 145<br>Note2 |      | ns   |
|                               |                     | 1.8 V ≤ EV <sub>DD0</sub> < 2.7 V,<br>C <sub>b</sub> = 100 pF, R <sub>b</sub> = 5 kΩ  | 1/f <sub>MCK</sub><br>+ 230<br>Note2 |      | 1/f <sub>MCK</sub><br>+ 230<br>Note2 |      | 1/f <sub>MCK</sub><br>+ 230<br>Note2 |      | ns   |
|                               |                     | 1.7 V ≤ EV <sub>DD0</sub> < 1.8 V,<br>C <sub>b</sub> = 100 pF, R <sub>b</sub> = 5 kΩ  | 1/f <sub>MCK</sub><br>+ 290<br>Note2 |      | 1/f <sub>MCK</sub><br>+ 290<br>Note2 |      | 1/f <sub>MCK</sub><br>+ 290<br>Note2 |      | ns   |
|                               |                     | 1.6 V ≤ EV <sub>DD0</sub> < 1.8 V,<br>C <sub>b</sub> = 100 pF, R <sub>b</sub> = 5 kΩ  | —                                    |      | 1/f <sub>MCK</sub><br>+ 290<br>Note2 |      | 1/f <sub>MCK</sub><br>+ 290<br>Note2 |      | ns   |
| Data hold time (transmission) | t <sub>HD:DAT</sub> | 2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V,<br>C <sub>b</sub> = 50 pF, R <sub>b</sub> = 2.7 kΩ | 0                                    | 305  | 0                                    | 305  | 0                                    | 305  | ns   |
|                               |                     | 1.8 V ≤ EV <sub>DD0</sub> ≤ 5.5 V,<br>C <sub>b</sub> = 100 pF, R <sub>b</sub> = 3 kΩ  | 0                                    | 355  | 0                                    | 355  | 0                                    | 355  | ns   |
|                               |                     | 1.8 V ≤ EV <sub>DD0</sub> < 2.7 V,<br>C <sub>b</sub> = 100 pF, R <sub>b</sub> = 5 kΩ  | 0                                    | 405  | 0                                    | 405  | 0                                    | 405  | ns   |
|                               |                     | 1.7 V ≤ EV <sub>DD0</sub> < 1.8 V,<br>C <sub>b</sub> = 100 pF, R <sub>b</sub> = 5 kΩ  | 0                                    | 405  | 0                                    | 405  | 0                                    | 405  | ns   |
|                               |                     | 1.6 V ≤ EV <sub>DD0</sub> < 1.8 V,<br>C <sub>b</sub> = 100 pF, R <sub>b</sub> = 5 kΩ  | —                                    |      | 0                                    | 405  | 0                                    | 405  | ns   |

**Notes** 1. The value must also be equal to or less than f<sub>MCK</sub>/4.2. Set the f<sub>MCK</sub> value to keep the hold time of SCLr = "L" and SCLr = "H".

**Caution** Select the normal input buffer and the N-ch open drain output (V<sub>DD</sub> tolerance (When 20- to 52-pin products)/EV<sub>DD</sub> tolerance (When 64- to 128-pin products)) mode for the SDAr pin and the normal output mode for the SCLr pin by using port input mode register g (PIMg) and port output mode register h (POMh).

(Remarks are listed on the next page.)

3. The smaller maximum transfer rate derived by using f<sub>MCK</sub>/6 or the following expression is the valid maximum transfer rate.

Expression for calculating the transfer rate when 2.7 V ≤ EV<sub>DD0</sub> < 4.0 V and 2.3 V ≤ V<sub>b</sub> ≤ 2.7 V

$$\text{Maximum transfer rate} = \frac{1}{\{-C_b \times R_b \times \ln(1 - \frac{2.0}{V_b})\} \times 3} \text{ [bps]}$$

$$\text{Baud rate error (theoretical value)} = \frac{\frac{1}{\text{Transfer rate} \times 2} - \{-C_b \times R_b \times \ln(1 - \frac{2.0}{V_b})\}}{(\frac{1}{\text{Transfer rate}}) \times \text{Number of transferred bits}} \times 100 \text{ [%]}$$

\* This value is the theoretical value of the relative difference between the transmission and reception sides.

4. This value as an example is calculated when the conditions described in the “Conditions” column are met. Refer to Note 3 above to calculate the maximum transfer rate under conditions of the customer.
5. Use it with EV<sub>DD0</sub> ≥ V<sub>b</sub>.
6. The smaller maximum transfer rate derived by using f<sub>MCK</sub>/6 or the following expression is the valid maximum transfer rate.

Expression for calculating the transfer rate when 1.8 V ≤ EV<sub>DD0</sub> < 3.3 V and 1.6 V ≤ V<sub>b</sub> ≤ 2.0 V

$$\text{Maximum transfer rate} = \frac{1}{\{-C_b \times R_b \times \ln(1 - \frac{1.5}{V_b})\} \times 3} \text{ [bps]}$$

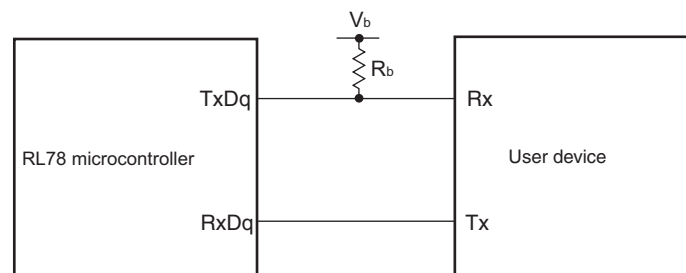
$$\text{Baud rate error (theoretical value)} = \frac{\frac{1}{\text{Transfer rate} \times 2} - \{-C_b \times R_b \times \ln(1 - \frac{1.5}{V_b})\}}{(\frac{1}{\text{Transfer rate}}) \times \text{Number of transferred bits}} \times 100 \text{ [%]}$$

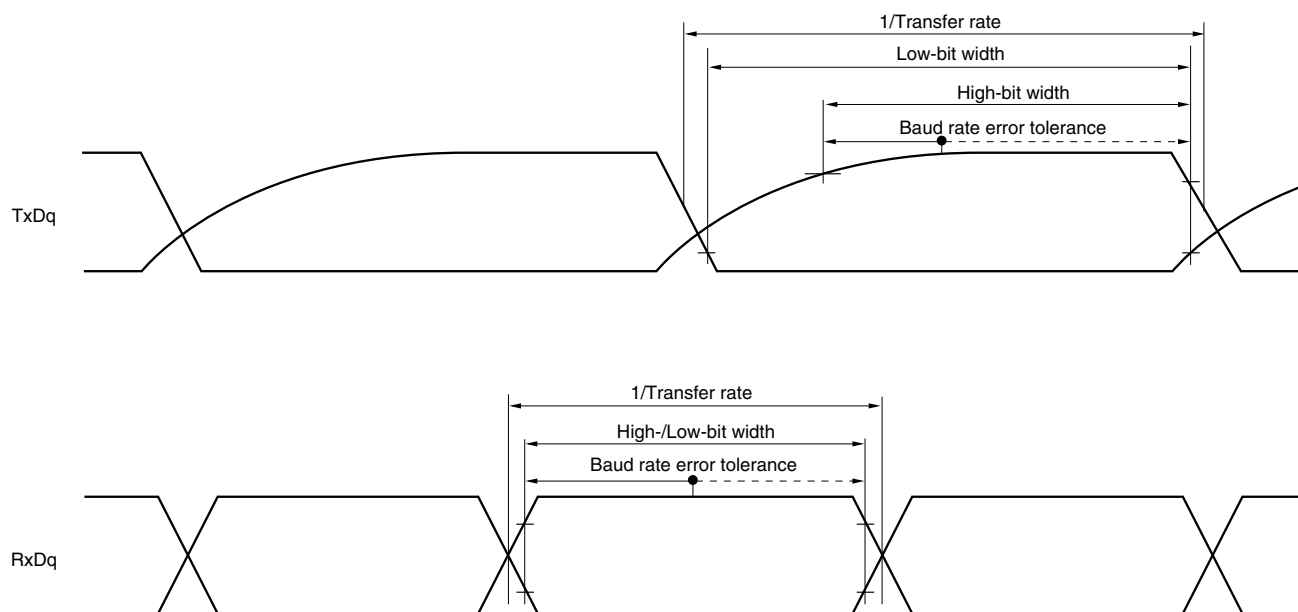
\* This value is the theoretical value of the relative difference between the transmission and reception sides.

7. This value as an example is calculated when the conditions described in the “Conditions” column are met. Refer to Note 6 above to calculate the maximum transfer rate under conditions of the customer.

**Caution** Select the TTL input buffer for the Rx<sub>Dq</sub> pin and the N-ch open drain output (V<sub>DD</sub> tolerance (When 20- to 52-pin products)/EV<sub>DD</sub> tolerance (When 64- to 128-pin products)) mode for the Tx<sub>Dq</sub> pin by using port input mode register g (PIMg) and port output mode register g (POMg). For V<sub>IH</sub> and V<sub>IL</sub>, see the DC characteristics with TTL input buffer selected.

UART mode connection diagram (during communication at different potential)



**UART mode bit width (during communication at different potential) (reference)**

- Remarks**
1.  $R_b[\Omega]$ : Communication line (TxDq) pull-up resistance,  
 $C_b[\text{F}]$ : Communication line (TxDq) load capacitance,  $V_b[\text{V}]$ : Communication line voltage
  2. q: UART number (q = 0 to 3), g: PIM and POM number (g = 0, 1, 8, 14)
  3.  $f_{\text{MCK}}$ : Serial array unit operation clock frequency  
 (Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn).  
 m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13))
  4. UART2 cannot communicate at different potential when bit 1 (PIOR1) of peripheral I/O redirection register (PIOR) is 1.

(3) When reference voltage (+) = V<sub>DD</sub> (ADREFP1 = 0, ADREFP0 = 0), reference voltage (–) = V<sub>SS</sub> (ADREFM = 0), target pin : ANI0 to ANI14, ANI16 to ANI26, internal reference voltage, and temperature sensor output voltage

(T<sub>A</sub> = –40 to +85°C, 1.6 V ≤ EV<sub>DD0</sub> = EV<sub>DD1</sub> ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS0</sub> = EV<sub>SS1</sub> = 0 V, Reference voltage (+) = V<sub>DD</sub>, Reference voltage (–) = V<sub>SS</sub>)

| Parameter                                      | Symbol            | Conditions   |  | MIN.   | TYP. | MAX.              | Unit |
|--|-------------------|--|--|--------|------|-------------------|------|
| Resolution                                     | RES               |  |  | 8      |      | 10                | bit  |
| Overall error <sup>Note 1</sup>                | AINL              | 10-bit resolution  | 1.8 V ≤ V <sub>DD</sub> ≤ 5.5 V                          |        | 1.2  | ±7.0              | LSB  |
|  |                   |  | 1.6 V ≤ V <sub>DD</sub> ≤ 5.5 V<br><small>Note 3</small> |        | 1.2  | ±10.5             | LSB  |
| Conversion time                                | t <sub>CONV</sub> | 10-bit resolution<br>Target pin: ANI0 to ANI14,<br>ANI16 to ANI26  | 3.6 V ≤ V <sub>DD</sub> ≤ 5.5 V                          | 2.125  |      | 39                | μs   |
|  |                   |  | 2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V                          | 3.1875 |      | 39                | μs   |
|  |                   |  | 1.8 V ≤ V <sub>DD</sub> ≤ 5.5 V                          | 17     |      | 39                | μs   |
|  |                   |  | 1.6 V ≤ V <sub>DD</sub> ≤ 5.5 V                          | 57     |      | 95                | μs   |
| Conversion time                                | t <sub>CONV</sub> | 10-bit resolution<br>Target pin: Internal<br>reference voltage, and<br>temperature sensor output<br>voltage (HS (high-speed<br>main) mode) | 3.6 V ≤ V <sub>DD</sub> ≤ 5.5 V                          | 2.375  |      | 39                | μs   |
|  |                   |  | 2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V                          | 3.5625 |      | 39                | μs   |
|  |                   |  | 2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V                          | 17     |      | 39                | μs   |
| Zero-scale error <sup>Notes 1, 2</sup>         | E <sub>ZS</sub>   | 10-bit resolution  | 1.8 V ≤ V <sub>DD</sub> ≤ 5.5 V                          |        |      | ±0.60             | %FSR |
|  |                   |  | 1.6 V ≤ V <sub>DD</sub> ≤ 5.5 V<br><small>Note 3</small> |        |      | ±0.85             | %FSR |
| Full-scale error <sup>Notes 1, 2</sup>         | E <sub>FS</sub>   | 10-bit resolution  | 1.8 V ≤ V <sub>DD</sub> ≤ 5.5 V                          |        |      | ±0.60             | %FSR |
|  |                   |  | 1.6 V ≤ V <sub>DD</sub> ≤ 5.5 V<br><small>Note 3</small> |        |      | ±0.85             | %FSR |
| Integral linearity error <sup>Note 1</sup>     | ILE               | 10-bit resolution  | 1.8 V ≤ V <sub>DD</sub> ≤ 5.5 V                          |        |      | ±4.0              | LSB  |
|  |                   |  | 1.6 V ≤ V <sub>DD</sub> ≤ 5.5 V<br><small>Note 3</small> |        |      | ±6.5              | LSB  |
| Differential linearity error <sup>Note 1</sup> | DLE               | 10-bit resolution  | 1.8 V ≤ V <sub>DD</sub> ≤ 5.5 V                          |        |      | ±2.0              | LSB  |
|  |                   |  | 1.6 V ≤ V <sub>DD</sub> ≤ 5.5 V<br><small>Note 3</small> |        |      | ±2.5              | LSB  |
| Analog input voltage                           | V <sub>AIN</sub>  | ANI0 to ANI14  | 0  |        |      | V <sub>DD</sub>   | V    |
|  |                   | ANI16 to ANI26   | 0  |        |      | EV <sub>DD0</sub> | V    |
|  |                   | Internal reference voltage<br>(2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V, HS (high-speed main) mode)   | V <sub>BGR</sub> <sup>Note 4</sup>                       |        |      |                   | V    |
|  |                   | Temperature sensor output voltage<br>(2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V, HS (high-speed main) mode)  | V <sub>TMPS25</sub> <sup>Note 4</sup>                    |        |      |                   | V    |

**Notes** 1. Excludes quantization error (±1/2 LSB).

2. This value is indicated as a ratio (%FSR) to the full-scale value.

3. When the conversion time is set to 57 μs (min.) and 95 μs (max.).

4. Refer to 2.6.2 Temperature sensor/internal reference voltage characteristics.

## 2.6.2 Temperature sensor/internal reference voltage characteristics

(T<sub>A</sub> =  $-40$  to  $+85^\circ\text{C}$ ,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ , HS (high-speed main) mode)

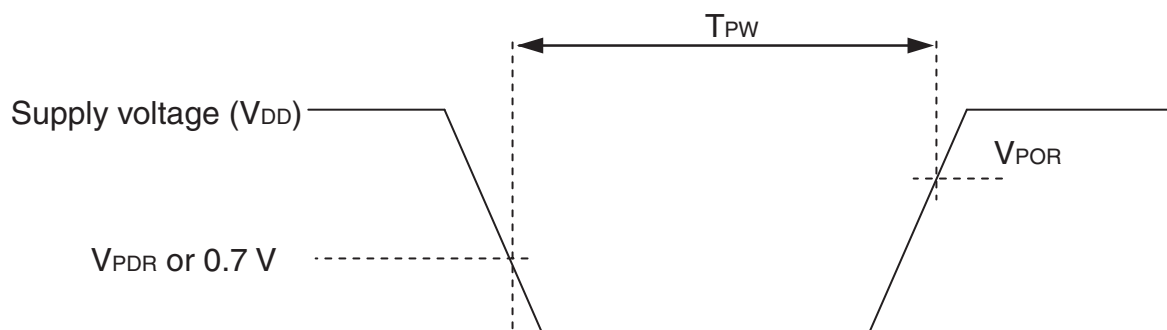
| Parameter                         | Symbol       | Conditions  | MIN. | TYP. | MAX. | Unit                 |
|-----------------------------------|--------------|---|------|------|------|----------------------|
| Temperature sensor output voltage | $V_{TMPS25}$ | Setting ADS register = 80H, $T_A = +25^\circ\text{C}$ |      | 1.05 |      | V                    |
| Internal reference voltage        | $V_{BGR}$    | Setting ADS register = 81H                            | 1.38 | 1.45 | 1.5  | V                    |
| Temperature coefficient           | $F_{VTMPS}$  | Temperature sensor that depends on the temperature    |      | -3.6 |      | mV/ $^\circ\text{C}$ |
| Operation stabilization wait time | $t_{AMP}$    |   | 5    |      |      | $\mu\text{s}$        |

## 2.6.3 POR circuit characteristics

(T<sub>A</sub> =  $-40$  to  $+85^\circ\text{C}$ ,  $V_{SS} = 0\text{ V}$ )

| Parameter                           | Symbol    | Conditions             | MIN. | TYP. | MAX. | Unit          |
|-------------------------------------|-----------|------------------------|------|------|------|---------------|
| Detection voltage                   | $V_{POR}$ | Power supply rise time | 1.47 | 1.51 | 1.55 | V             |
|                                     | $V_{PDR}$ | Power supply fall time | 1.46 | 1.50 | 1.54 | V             |
| Minimum pulse width <sup>Note</sup> | $T_{PW}$  |                        | 300  |      |      | $\mu\text{s}$ |

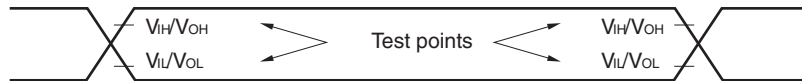
**Note** Minimum time required for a POR reset when  $V_{DD}$  exceeds below  $V_{PDR}$ . This is also the minimum time required for a POR reset from when  $V_{DD}$  exceeds below 0.7 V to when  $V_{DD}$  exceeds  $V_{POR}$  while STOP mode is entered or the main system clock is stopped through setting bit 0 (HIOSSTOP) and bit 7 (MSTOP) in the clock operation status control register (CSC).





### 3.5 Peripheral Functions Characteristics

#### AC Timing Test Points



#### 3.5.1 Serial array unit

##### (1) During communication at same potential (UART mode)

( $T_A = -40$  to  $+105^\circ\text{C}$ ,  $2.4\text{ V} \leq E_{VDD0} = E_{VDD1} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = E_{VSS0} = E_{VSS1} = 0\text{ V}$ )

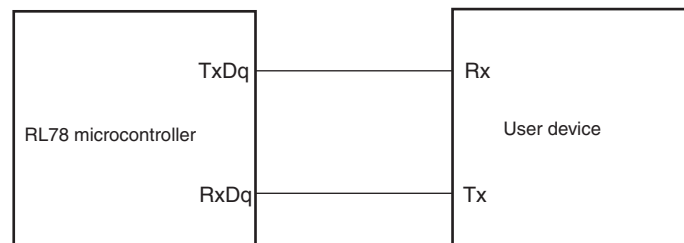
| Parameter                       | Symbol | Conditions  | HS (high-speed main) Mode |                                | Unit |
|---------------------------------|--------|---|---------------------------|--------------------------------|------|
|                                 |        |   | MIN.                      | MAX.                           |      |
| Transfer rate <sup>Note 1</sup> |        | Theoretical value of the maximum transfer rate<br>$f_{CLK} = 32\text{ MHz}$ , $f_{MCK} = f_{CLK}$ |                           | $f_{MCK}/12$ <sup>Note 2</sup> | bps  |
|                                 |        |   |                           | 2.6                            | Mbps |

**Notes 1.** Transfer rate in the SNOOZE mode is 4800 bps only.

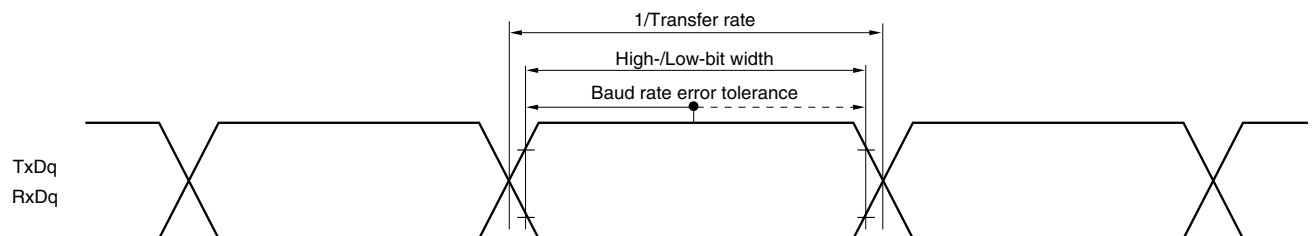
**2.** The following conditions are required for low voltage interface when  $E_{VDD0} < V_{DD}$ .  
 $2.4\text{ V} \leq E_{VDD0} < 2.7\text{ V}$  : MAX. 1.3 Mbps

**Caution** Select the normal input buffer for the RxDq pin and the normal output mode for the TxDq pin by using port input mode register g (PIMg) and port output mode register g (POMg).

#### UART mode connection diagram (during communication at same potential)



#### UART mode bit width (during communication at same potential) (reference)

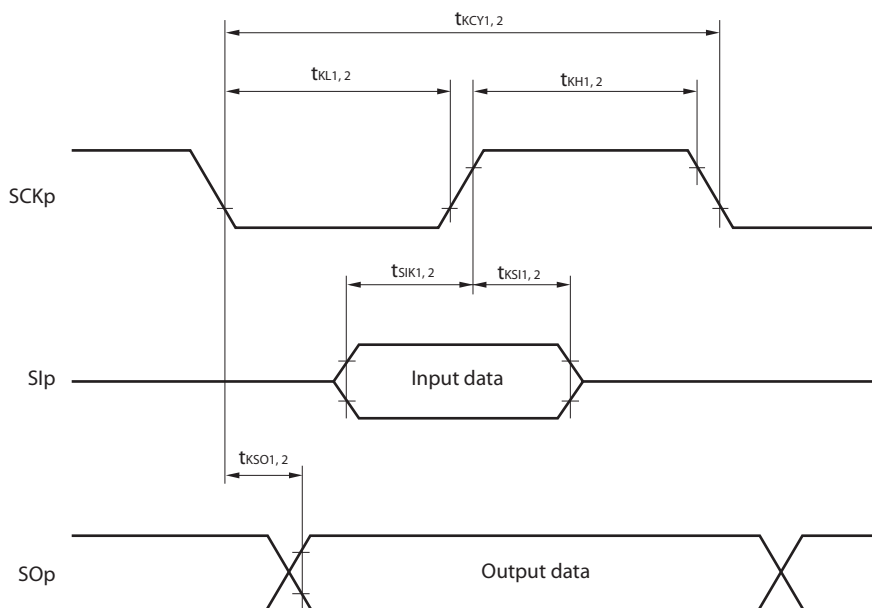


**Remarks 1.** q: UART number (q = 0 to 3), g: PIM and POM number (g = 0, 1, 8, 14)

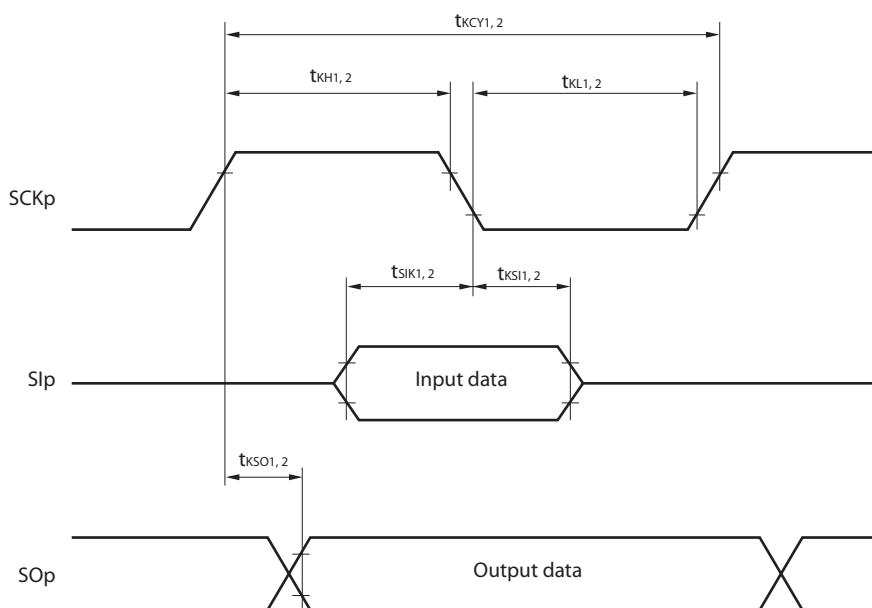
**2.**  $f_{MCK}$ : Serial array unit operation clock frequency

(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13))

**CSI mode serial transfer timing (during communication at same potential)**  
**(When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1.)**



**CSI mode serial transfer timing (during communication at same potential)**  
**(When DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.)**



- Remarks**
1. p: CSI number (p = 00, 01, 10, 11, 20, 21, 30, 31)
  2. m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13)

**(5) Communication at different potential (1.8 V, 2.5 V, 3 V) (UART mode) (1/2)****( $T_A = -40$  to  $+105^\circ\text{C}$ ,  $2.4\text{ V} \leq EV_{DD0} = EV_{DD1} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = EV_{SS0} = EV_{SS1} = 0\text{ V}$ )**

| Parameter     | Symbol | Conditions | HS (high-speed main) Mode  |      | Unit   |      |
|---------------|--------|------------|--|------|--|------|
|               |        |            | MIN.   | MAX. |  |      |
| Transfer rate |        | Reception  | 4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V,<br>2.7 V ≤ V <sub>b</sub> ≤ 4.0 V   |      | f <sub>MCK</sub> /12 <sup>Note 1</sup>       | bps  |
|               |        |            | Theoretical value of the maximum transfer rate<br>f <sub>CLK</sub> = 32 MHz, f <sub>MCK</sub> = f <sub>CLK</sub> |      | 2.6  | Mbps |
|               |        |            | 2.7 V ≤ EV <sub>DD0</sub> < 4.0 V,<br>2.3 V ≤ V <sub>b</sub> ≤ 2.7 V   |      | f <sub>MCK</sub> /12 <sup>Note 1</sup>       | bps  |
|               |        |            | Theoretical value of the maximum transfer rate<br>f <sub>CLK</sub> = 32 MHz, f <sub>MCK</sub> = f <sub>CLK</sub> |      | 2.6  | Mbps |
|               |        |            | 2.4 V ≤ EV <sub>DD0</sub> < 3.3 V,<br>1.6 V ≤ V <sub>b</sub> ≤ 2.0 V   |      | f <sub>MCK</sub> /12<br><sup>Notes 1,2</sup> | bps  |
|               |        |            | Theoretical value of the maximum transfer rate<br>f <sub>CLK</sub> = 32 MHz, f <sub>MCK</sub> = f <sub>CLK</sub> |      | 2.6  | Mbps |

**Notes 1.** Transfer rate in the SNOOZE mode is 4800 bps only.

- 2.** The following conditions are required for low voltage interface when  $EV_{DD0} < V_{DD}$ .  
 $2.4\text{ V} \leq EV_{DD0} < 2.7\text{ V}$  : MAX. 1.3 Mbps

**Caution** Select the TTL input buffer for the RxDq pin and the N-ch open drain output ( $V_{DD}$  tolerance (for the 20- to 52-pin products)/ $EV_{DD}$  tolerance (for the 64- to 100-pin products)) mode for the TxDq pin by using port input mode register g (PIMg) and port output mode register g (POMg). For  $V_{IH}$  and  $V_{IL}$ , see the DC characteristics with TTL input buffer selected.

**Remarks 1.**  $V_b[V]$ : Communication line voltage**2.** q: UART number (q = 0 to 3), g: PIM and POM number (g = 0, 1, 8, 14)**3.**  $f_{MCK}$ : Serial array unit operation clock frequency

(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13))

**4.** UART2 cannot communicate at different potential when bit 1 (PIOR1) of peripheral I/O redirection register (PIOR) is 1.

5. The smaller maximum transfer rate derived by using  $f_{MCK}/12$  or the following expression is the valid maximum transfer rate.

Expression for calculating the transfer rate when  $2.4\text{ V} \leq EV_{DD0} < 3.3\text{ V}$  and  $1.6\text{ V} \leq V_b \leq 2.0\text{ V}$

$$\text{Maximum transfer rate} = \frac{1}{\{-C_b \times R_b \times \ln(1 - \frac{1.5}{V_b})\} \times 3} \text{ [bps]}$$

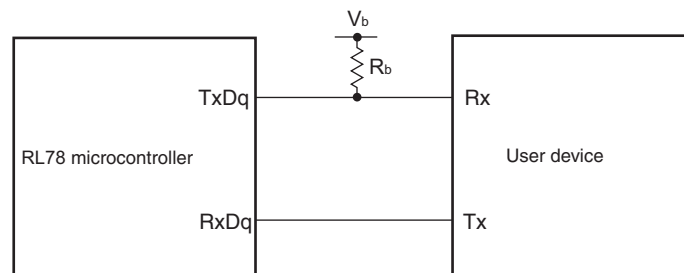
$$\text{Baud rate error (theoretical value)} = \frac{\frac{1}{\text{Transfer rate} \times 2} - \{-C_b \times R_b \times \ln(1 - \frac{1.5}{V_b})\}}{(\frac{1}{\text{Transfer rate}}) \times \text{Number of transferred bits}} \times 100 \text{ [%]}$$

\* This value is the theoretical value of the relative difference between the transmission and reception sides.

6. This value as an example is calculated when the conditions described in the “Conditions” column are met. Refer to Note 5 above to calculate the maximum transfer rate under conditions of the customer.

**Caution** Select the TTL input buffer for the RxDq pin and the N-ch open drain output ( $V_{DD}$  tolerance (for the 20- to 52-pin products)/ $EV_{DD}$  tolerance (for the 64- to 100-pin products)) mode for the TxDq pin by using port input mode register g (PIMg) and port output mode register g (POMg). For  $V_{IH}$  and  $V_{IL}$ , see the DC characteristics with TTL input buffer selected.

UART mode connection diagram (during communication at different potential)



## 4.2 24-pin Products

R5F1007AANA, R5F1007CANA, R5F1007DANA, R5F1007EANA  
 R5F1017AANA, R5F1017CANA, R5F1017DANA, R5F1017EANA  
 R5F1007ADNA, R5F1007CDNA, R5F1007DDNA, R5F1007EDNA  
 R5F1017ADNA, R5F1017CDNA, R5F1017DDNA, R5F1017EDNA  
 R5F1007AGNA, R5F1007CGNA, R5F1007DGNA, R5F1007EGNA

| JEITA Package code | RENESAS code | Previous code  | MASS(TYP.)[g] |
|--------------------|--------------|----------------|---------------|
| P-HWQFN24-4x4-0.50 | PWQN0024KE-A | P24K8-50-CAB-3 | 0.04          |

